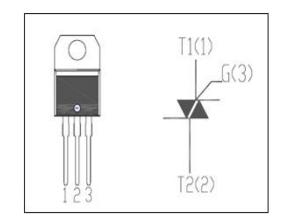


DESCRIPTION

- With TO-3PN packaging
- · Operating in 4 quadrants
- · High voltage capability; high current capability
- Minimum Lot-to-Lot variations for robust device performance and reliable operation

APPLICATIONS

- · Applications subject to high temperature
- Heating controls; high power motor control
- · High power switching



ABSOLUTE MAXIMUM RATINGS(T_a=25°C)

SYMBOL	PARAMETER			UNIT
V _{DRM}	Repetitive peak off-state voltage			V
V_{RRM}	Repetitive peak reverse voltage			V
I _{T(RSM)}	RSM average on-state current Tc=90 ℃			Α
I _{TSM}	Surge non-repetitive on-state current	50HZ 60HZ	250 260	А
$P_{G(AV)}$	Average gate power dissipation (over any 20 ms period) @ Tc=125℃			W
T _j	Operating junction temperature			$^{\circ}\mathbb{C}$
T _{stg}	Storage temperature			$^{\circ}$

ELECTRICAL CHARACTERISTICS (Tc=25℃ unless otherwise specified)

SYMBOL	PARAMETER	CONDITIONS			MIN	MAX	UNIT
I _{RRM}	Repetitive peak reverse current	V _R =V _{RRM} Rated;	Tj=25℃	7		5	μ Α
I _{DRM}	Repetitive peak off-state current	V _D =V _{DRM} Rated;	Tj=125℃			3	mA
V_{TM}	On-state voltage	I _T =35A;t _P =380 μs				1.55	V
Іст	Gate-trigger current			I		50	mA
		$V_D = 12V; R_L = 33\Omega;$		II	50		
		VD = 12 V,NL=3322,		III		50	
				IV		100	
V_{GT}	Gate-trigger voltage	$V_D = 12V; R_L = 33\Omega;$				1.3	V
Rth(j-c)	Junction to case					1.1	°C/W